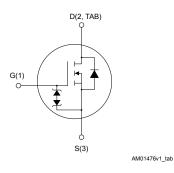


# N-channel 600 V, 35 mΩ typ., 63 A MDmesh M6 Power MOSFET in a TO-247 long leads package





#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STWA68N60M6	600 V	41 mΩ	63 A

- Reduced switching losses
- Lower R<sub>DS(on)</sub> per area vs previous generation
- · Low gate input resistance
- 100% avalanche tested
- Zener-protected

#### **Applications**

- Switching applications
- LLC converters
- Boost PFC converters

#### **Description**

The new MDmesh M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent  $R_{DS(on)}$  per area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum end-application efficiency.



# Maturity status link STWA68N60M6

Device summary			
Order code STWA68N60M6			
Marking	68N60M6		
Package	TO-247 long leads		
Packing	Tube		



## 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	±25	V
1_	Drain current (continuous) at T <sub>C</sub> = 25 °C	63	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	40	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	252	Α
P <sub>TOT</sub>	Total power dissipation at T <sub>C</sub> = 25 °C	390	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	100	V/IIS
T <sub>stg</sub>	Storage temperature range	-55 to 150	°C
Tj	Operating junction temperature range	-55 (0 150	

- 1. Pulse width is limited by safe operating area.
- 2.  $I_{SD} \le 63~A$ ,  $di/dt \le 400~A/\mu s$ ,  $V_{DS(peak)} < V_{(BR)DSS}$ ,  $V_{DD} = 400~V$
- 3.  $V_{DS} \le 480 \text{ V}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance, junction-to-case	0.32	°C/W
R <sub>thJA</sub>	Thermal resistance, junction-to-ambient	50	°C/W

**Table 3. Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )	7.5	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	1100	mJ

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### 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4. On /off-states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
	7	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 600 V			1	
I <sub>DSS</sub>	Zero-gate voltage drain current	$V_{GS} = 0 \text{ V},$ $V_{DS} = 600 \text{ V}, T_{C} = 125 ^{\circ}\text{C}^{(1)}$			100	μА
I <sub>GSS</sub>	Gate-body leakage current	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±25 V			±5	μA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.25	4	4.75	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 31.5 A		35	41	mΩ

<sup>1.</sup> Specified by design, not tested in production.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	4360	-	pF
C <sub>oss</sub>	Output capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V}, f = 1$ MHz	-	235	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	13	-	pF
Coss eq. (1)	Equivalent output capacitance	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 to 480 V	-	713	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	1.6	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 63 A,	-	106	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	29	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14. Test circuit for gate charge behavior)	-	51	-	nC

<sup>1.</sup>  $C_{\text{oss eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{\text{oss}}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d (on)</sub>	Turn-on delay time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 30 A,	-	42	-	ns
t <sub>r</sub>	Rise time	$R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 10 $V$ (see Figure 13. Test circuit for resistive load switching times and Figure 18. Switching time waveform)	-	28	-	ns
t <sub>d(off)</sub>	Turn-off delay time		-	130	-	ns
t <sub>f</sub>	Fall time		-	8	-	ns

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Table 7. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		63	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		252	Α
V <sub>SD</sub> (2)	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 63 A	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 63 A, di/dt = 100 A/μs,	-	308		ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 60 V (see	-	4.3		μC
I <sub>RRM</sub>	Reverse recovery current	Figure 15. Test circuit for inductive load switching and diode recovery times)	-	26		А
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 63 A, di/dt = 100 A/μs,	-	504		ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 60 V, T <sub>j</sub> = 150 °C	-	10.8		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	38		А

<sup>1.</sup> Pulse width is limited by safe operating area.

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<sup>2.</sup> Pulse test: pulse duration = 300  $\mu$ s, duty cycle 1.5%.



#### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area GADG210320171546SOA Operation in this area is limited by R DS(on) t<sub>p</sub> =1 μs 10<sup>2</sup> t<sub>o</sub> =10 μs t₀ =100 µs 10 1 t<sub>0</sub> =1 ms T<sub>J</sub>≤150 °C t₀ =10 ms T<sub>C</sub>=25 °C 10 º V<sub>GS</sub>=10 V single pulse 10 -1

10 ¹

10<sup>2</sup>

10 -1

10 º

V<sub>DS</sub> (V)

Figure 2. Thermal impedance

K

AM09125v1

0.0

0.02

Zth=k \* R<sub>th</sub>JC

δ=tp/τ

10<sup>2</sup>

10<sup>4</sup>

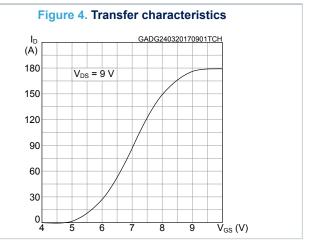
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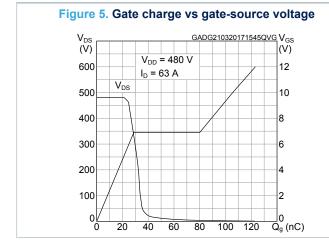
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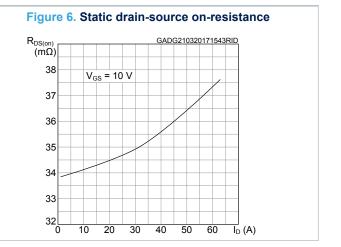
10<sup>1</sup>

tp(s)

Figure 3. Output characteristics I<sub>D</sub> (A) GADG210320171544OCH V<sub>GS</sub> =10 V V<sub>GS</sub> =9 V 180 V<sub>GS</sub> =8 V 150 120 V<sub>GS</sub> =7 V 90 60 V<sub>GS</sub> =6 V 30 10  $\overrightarrow{V}_{DS}(V)$ 







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Figure 7. Capacitance variations

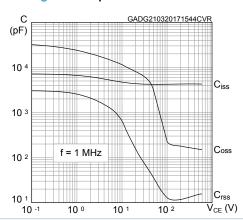


Figure 8. Normalized gate threshold vs. temperature

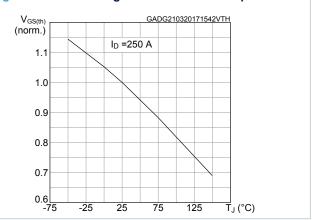


Figure 9. Normalized on-resistance vs. temperature

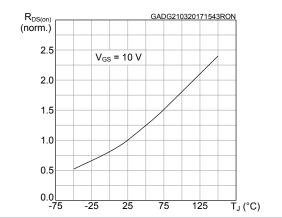


Figure 10. Normalized  $V_{(BR)DSS}$  vs. temperature

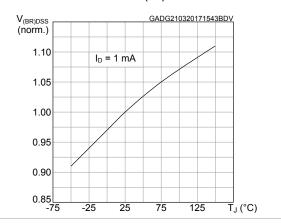


Figure 11. Output capacitance stored energy

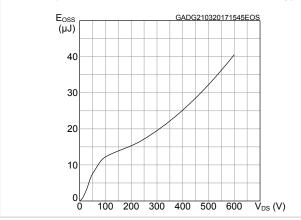
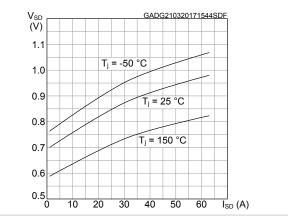


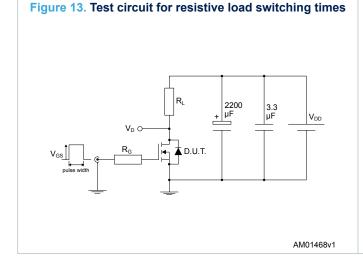
Figure 12. Source-drain diode forward characteristics



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### 3 Test circuits



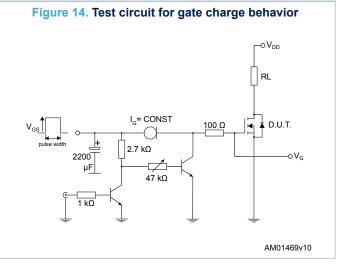
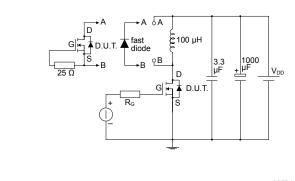


Figure 15. Test circuit for inductive load switching and diode recovery times



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Figure 16. Unclamped inductive load test circuit

Figure 17. Unclamped inductive waveform

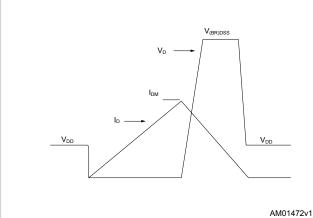
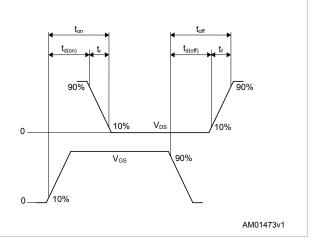


Figure 18. Switching time waveform



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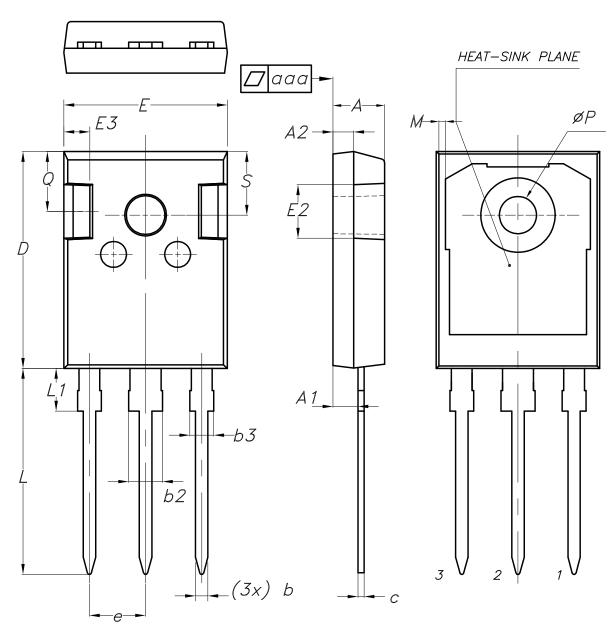


## 4 Package information

To meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions, and product status are available at: www.st.com. ECOPACK is an ST trademark.

#### 4.1 TO-247 long leads package information

Figure 19. TO-247 long leads package outline



BACK VIEW

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Table 8. TO-247 long leads package mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
С	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
е	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
M	0.35		0.95
Р	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25
aaa		0.04	0.10

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## **Revision history**

Table 9. Document revision history

Date	Revision	Changes
03-Apr-2017	1	First release.
05-Nov-2018	2	Removed maturity status indication from cover page. The document status is production data.  Modified Table 1. Absolute maximum ratings, Table 5. Dynamic and Table 7. Source-drain diode.  Modified Figure 1. Safe operating area, Figure 3. Output characteristics, Figure 4. Transfer characteristics, Figure 5. Gate charge vs gate-source voltage, Figure 6. Static drain-source on-resistance, Figure 7. Capacitance variations, Figure 8. Normalized gate threshold vs. temperature, Figure 9. Normalized on-resistance vs. temperature, Figure 10. Normalized V(BR)DSS vs. temperature and Figure 12. Source-drain diode forward characteristics.  Minor text changes.
03-Nov-2024	3	Updated Section 4.1: TO-247 long leads package information.  Minor text changes.

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